Special Issue

Multisensor Fusion: Latest Advances and Prospects

Message from the Guest Editors

First and foremost, the scope of the call for papers for this Special Issue is to study how wireless sensor networks transfer sensing data to front-end integrated data center units for fusion of sensing data. When the system completes the fusion of sensing data, the system will transmit the processed data to the entire system data processing center for encapsulation of blockchain algorithms or other data encryption and security methods. Of course, any multi-sensor data fusion is within the scope of our Special Issue call for papers. In addition, when the sensing data is fused, how to transmit the data and how to ensure data security also encompass the research scope of our Special Issue call for papers.

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Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guestedited by leading experts in selected topics of interest.

Editor-in-Chief

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